



STPC CONSUMER

Multimedia PC on a Chip

- POWERFUL X86 PROCESSOR
- 64-BIT 66MHz BUS INTERFACE
- 64-BIT DRAM CONTROLLER
- SVGA GRAPHICS CONTROLLER
- UMA ARCHITECTURE
- VIDEO SCALER
- DIGITAL PAL/NTSC ENCODER
- VIDEO INPUT PORT
- CRT CONTROLLER
- 135MHz RAMDAC
- 2 OR 3 LINE FLICKER FILTER
- SCAN CONVERTER
- PCI MASTER / SLAVE / ARBITER
- ISA MASTER/SLAVE
- IDE CONTROLLER
- DMA CONTROLLER
- INTERRUPT CONTROLLER
- TIMER / COUNTERS
- POWER MANAGEMENT

DESCRIPTION

The STPC Consumer integrates a fully static x86 processor, fully compatible with standard fifth generation x86 processors, and combines it with powerful chipset, graphics and video pipelines to provide a single Consumer orientated PC compatible subsystem on a single device. The performance of the device is comparable with the performance of a typical P5 generation system. The device is packaged in a 388 Ball Grid Array (PBGA)

- **X86 Processor core**
- Fully static 32-bit 5-stage pipeline, x86 processor fully PC compatible.
- Can access up to 4GB of external memory.
- 8Kbyte unified instruction and data cache with write back and write through capability.

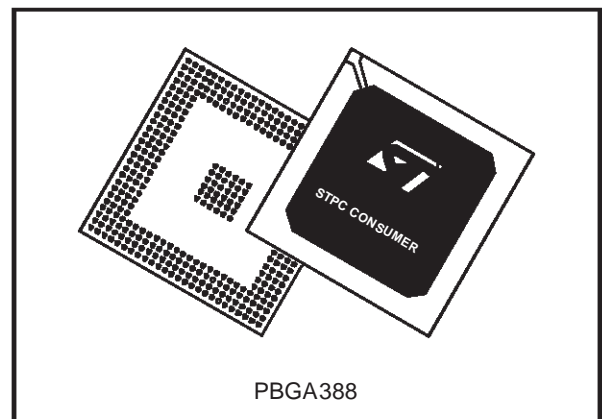
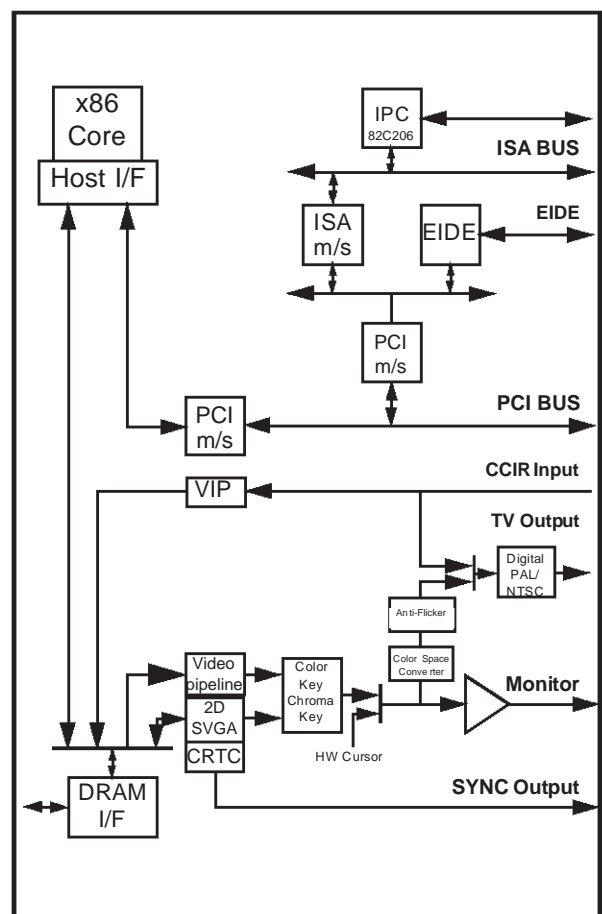


Figure 1. Logic Diagram



- Parallel processing integral floating point unit, with automatic power down.
- Clock core speeds up to of 133 MHz.
- Fully static design for dynamic clock control.
- Low power and system management modes.
- Optimized design for 3.3V operation.
- **DRAM Controller**
- Integrated system memory and graphic frame memory.
- Supports up to 128 MBytes system memory in 4 banks and as little as 2Mbytes.
- Supports 4MB, 8MB, 16MB, 32MB single-sided and double-sided DRAM SIMMs.
- Four quad-word write buffers for CPU to DRAM and PCI to DRAM cycles.
- Four 4-word read buffers for PCI masters.
- Supports Fast Page Mode & EDO DRAMs.
- Programmable timing for DRAM parameters including CAS pulse width, CAS pre-charge time, and RAS to CAS delay.
- 60, 70, 80 & 100ns DRAM speeds.
- Memory hole between 1 MByte & 8 MByte supported for PCI/ISA busses.
- Hidden refresh.
- **Graphics Controller**
- 64-bit windows accelerator.
- Backward compatibility to SVGA standards.
- Hardware acceleration for text, bitblts, transparent blts and fills.
- Up to 64 x 64 bit graphics hardware cursor.
- Up to 4MB long linear frame buffer.
- 8-, 16-, and 24-bit pixels.
- Drivers for Windows and other operating systems.
- **CRT Controller**
- Integrated 135MHz triple RAMDAC allowing for 1024 x 768 x 75Hz display.
- Requires external frequency synthesizer and reference sources.
- 8-, 16-, 24-bit pixels.
- Interlaced or non-interlaced output.
- **Video Input port**
- Accepts video inputs in CCIR 601/656 or ITU-R 601/656, and decodes the stream.
- Optional 2:1 decimator
- Stores captured video in off setting area of the onboard frame buffer.
- Video pass through to the onboard PAL/NTSC encoder for full screen video images.
- HSYNC and B/T generation or lock onto external video timing source.
- **Video Pipeline**
- Two-tap interpolative horizontal filter.
- Two-tap interpolative vertical filter.
- Color space conversion (RGB to YUV and YUV to RGB).
- Programmable window size.
- Chroma and color keying for integrated video overlay.
- Programmable two tap filter with gamma correction or three tap flicker filter.
- Progressive to interlaced scan converter.
- **Digital NTSC/PAL encoder**
- NTSC-M, PAL-M, PAL-B,D,G,H,I, PAL-N easy programmable video outputs.
- CCIR601 encoding with programmable color subcarrier frequencies.
- Line skip/insert capability
- Selectable Macrovision 7.01/rev 6.1 copy protection in both NTSC & PAL
- Interlaced or non-interlaced operation mode.
- 625 lines/50Hz or 525 lines/60Hz 8 bit multiplexed CB-Y-CR digital input.
- CVBS and R,G,B simultaneous analog outputs through 10-bit DACs.
- Cross color reduction by specific trap filtering on luma within CVBS flow.
- Power down mode available on each DAC.
- **PCI Controller**
- Fully compliant with PCI 2.1 specification.
- Integrated PCI arbitration interface. Up to 3 masters can connect directly. External PAL allows for greater than 3 masters.
- Translation of PCI cycles to ISA bus.
- Translation of ISA master initiated cycle to PCI.
- Support for burst read/write from PCI master.
- 0.33X and 0.5X CPU clock PCI clock.

■ ISA master/slave

- Generates the ISA clock from either 14.318MHz oscillator clock or PCI clock
- Supports programmable extra wait state for ISA cycles
- Supports I/O recovery time for back to back I/O cycles.
- Fast Gate A20 and Fast reset.
- Supports the single ROM that C, D, or E. blocks shares with F block BIOS ROM.
- Supports flash ROM.
- Supports ISA hidden refresh.
- Buffered DMA & ISA master cycles to reduce bandwidth utilization of the PCI and Host bus. NSP compliant.

■ IDE Interface

- Supports PIO and Bus Master IDE
- Supports up to Mode 5 Timings
- Transfer Rates to 22 MBytes/sec
- Supports up to 4 IDE devices
- Concurrent channel operation (PIO & DMA modes) - 4 x 32-Bit Buffer FIFO per channel
- Support for PIO mode 3 & 4.
- Support for DMA mode 1 & 2.
- Support for 11.1/16.6 MB/s, I/O Channel Ready PIO data transfers.
- Supports 13.3/16.6 MB/s DMA data transfers
- Bus Master with scatter/gather capability

- Multi-word DMA support for fast IDE drives
- Individual drive timing for all four IDE devices
- Supports both legacy & native IDE modes
- Supports hard drives larger than 528MB
- Support for CD-ROM and tape peripherals
- Backward compatibility with IDE (ATA-1).
- Drivers for Windows and other OSes

■ Integrated peripheral controller

- 2X8237/AT compatible 7-channel DMA controller.
- 2X8259/AT compatible interrupt Controller. 16 interrupt inputs - ISA and PCI.
- Three 8254 compatible Timer/Counters.
- Co-processor error support logic.

■ Power Management

- Four power saving modes: On, Doze, Standby, Suspend.
- Programmable system activity detector
- Supports SMM and APM.
- Supports STOPCLK.
- Supports IO trap & restart.
- Independent peripheral time-out timer to monitor hard disk, serial & parallel ports.
- Slow system clock down to 8MHz
- Slow Host clock down to 8Hz
- Slow graphic clock down to 8Hz
- Supports RTC, interrupts and DMAs wake-up

1 GENERAL DESCRIPTION

At the heart of the STPC Consumer is an advanced processor block, dubbed the 5ST86. The 5ST86 includes a powerful x86 processor core along with a 64-bit DRAM controller, advanced 64bit accelerated graphics and video controller, a high speed PCI local-bus controller and Industry standard PC chip set functions (Interrupt controller, DMA Controller, Interval timer and ISA bus) and EIDE controller.

The STPC Consumer has in addition to the 5ST86 a Video subsystem and high quality digital Television output.

The STMicroelectronics x86 processor core is embedded with standard and application specific peripheral modules on the same silicon die. The core has all the functionality of the SGS-THOMSON standard x86 processor products, including the low power System Management Mode (SMM).

System Management Mode (SMM) provides an additional interrupt and address space that can be used for system power management or software transparent emulation of peripherals. While running in isolated SMM address space, the SMM interrupt routine can execute without interfering with the operating system or application programs.

Further power management facilities include a suspend mode that can be initiated from either hardware or software. Because of the static nature of the core, no internal data is lost.

The STPC Consumer makes use of a tightly coupled Unified Memory Architecture (UMA), where the same memory array is used for CPU main memory and graphics frame-buffer. This significantly reduces total system memory with system performances equal to that of a comparable solution with separate frame buffer and system memory. In addition, memory bandwidth is improved by attaching the graphics engine directly to the 64-bit processor host interface running at the speed of the processor bus rather than the traditional PCI bus.

The 64-bit wide memory array provides the system with 320MB/s peak bandwidth, double that of an equivalent system using 32 bits. This allows for higher screen resolutions and greater color depth. The processor bus runs at the speed of the processor (DX devices) or half the speed (DX2 devices).

The 'standard' PC chipset functions (DMA, interrupt controller, timers, power management logic) are integrated with the x86 processor core.

The PCI bus is the main data communication link to the STPC Consumer chip. The STPC Consumer translates appropriate host bus I/O and Memory cycles onto the PCI bus. It also supports generation of Configuration cycles on the PCI bus. The STPC Consumer, as a PCI bus agent (host bridge class), fully complies with PCI specification 2.1. The chip-set also implements the PCI mandatory header registers in Type 0 PCI configuration space for easy porting of PCI aware system BIOS. The device contains a PCI arbitration function for three external PCI devices.

The STPC Consumer integrates an ISA bus controller. Peripheral modules such as parallel and serial communications ports, keyboard controllers and additional ISA devices can be accessed by the STPC Consumer chip set through this bus.

An industry standard EIDE (ATA 2) controller is built in to the STPC Consumer and connected internally via the PCI bus.

Graphics functions are controlled by the on-chip SVGA controller and the monitor display is managed by the 2D graphics display engine.

This Graphics Engine is tuned to work with the host CPU to provide a balanced graphics system with a low silicon area cost. It performs limited graphics drawing operations, which include hardware acceleration of text, bitblts, transparent blits and fills. These operations can operate on off-screen or on-screen areas. The frame buffer size is up to 4 Mbytes anywhere in the physical main memory.

The graphics resolution supported is a maximum of 1280x1024 in 65536 colours at 75Hz refresh rate and is VGA and SVGA compatible. Horizontal timing fields are VGA compatible while the vertical fields are extended by one bit to accommodate above display resolution.

STPC Consumer provides several additional functions to handle MPEG or similar video streams. The Video Input Port accepts an encoded digital video stream in one of a number of industry standard formats, decodes it, optionally decimates it by a factor of 2:1, and deposits it into an off screen area of the frame buffer. An interrupt request can be generated when an entire field or frame has been captured.

The video output pipeline incorporates a video-scaler and color space converter function and provisions in the CRT controller to display a video window. While repainting the screen the CRT controller fetches both the video as well as the normal non-video frame buffer in two separate internal FIFOs (256-bytes each). The video stream can be color-space converted (optionally) and smooth scaled. Smooth interpolative scaling in both horizontal and vertical direction are implemented. Color and Chroma key functions are also implemented to allow mixing video stream with non-video frame buffer.

The video output passes directly to the RAMDAC for monitor output or through another optional color space converter (RGB to 4:2:2 YCrCb) to the programmable anti-flicker filter. The flicker filter is configured as either a two line filter with gamma correction (primarily designed for DOS type text) or a 3 line flicker filter (primarily designed for Windows type displays). The flicker filter is optional and can be software disabled for use with large screen area's of video.

The Video output pipeline of the STPC Consumer interfaces directly to the internal digital TV encoder. It takes a 24 bit RGB non-interlaced pixel stream and converts to a multiplexed 4:2:2 YCrCb 8 bit output stream, the logic includes a progressive to interlaced scan converter and logic to insert appropriate CCIR656 timing reference codes into the output stream. It facilitates the high quality display of VGA or full screen video streams received via the Video input port to standard NTSC or PAL televisions.

The STPC Consumer core is compliant with the Advanced Power Management (APM) specification to provide a standard method by which the BIOS can control the power used by personal computers. The Power Management Unit module (PMU) controls the power consumption by providing a comprehensive set of features that control the power usage and supports compliance with the United States Environmental Protection Agency's Energy Star Computer Program. The PMU provides following hardware structures to assist the software in managing the power consumption by the system.

- System Activity Detection.
- 3 power-down timers detecting system inactivity:
 - Doze timer (short durations).
 - Stand-by timer (medium durations).
 - Suspend timer (long durations).
- House-keeping activity detection.

- House-keeping timer to cope with short bursts of house-keeping activity while dozing or in stand-by state.

- Peripheral activity detection.

- Peripheral timer detecting peripheral inactivity

- SUSP# modulation to adjust the system performance in various power down states of the system including full power on state.

- Power control outputs to disable power from different planes of the board.

Lack of system activity for progressively longer period of times is detected by the three power down timers. These timers can generate SMI interrupts to CPU so that the SMM software can put the system in decreasing states of power consumption. Alternatively, system activity in a power down state can generate SMI interrupt to allow the software to bring the system back up to full power on state. The chip-set supports up to three power down states: Doze state, Stand-by state and Suspend mode. These correspond to decreasing levels of power savings.

Power down puts the STPC Consumer into suspend mode. The processor completes execution of the current instruction, any pending decoded instructions and associated bus cycles. During the suspend mode, internal clocks are stopped. removing power down, the processor resumes instruction fetching and begins execution in the instruction stream at the point it had stopped.

A reference design for the STPC Consumer is available including the schematics and layout files, the design is a PC ATX motherboard design. The design is available as a demonstration board for application and system development.

The STPC Consumer is supported by several BIOS vendors, including the super I/O device used in the reference design. Drivers for 2D accelerator, video features and EIDE are available on various operating systems.

The STPC Consumer has been designed using modern reusable modular design techniques, it is possible to add to or remove the standard features of the STPC Consumer or other variants of the 5ST86 family. Contact your local STMicroelectronics sales office for further information.

GENERAL DESCRIPTION

Figure 2. Interfaces

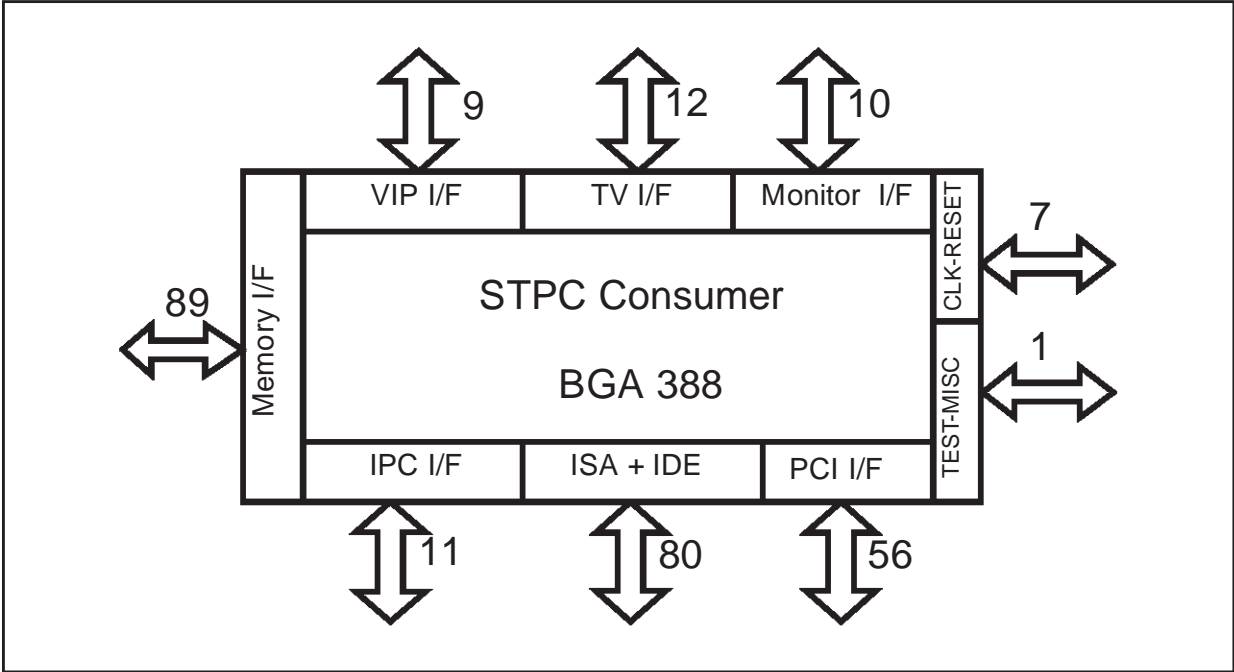


Figure 3. Die Highlight

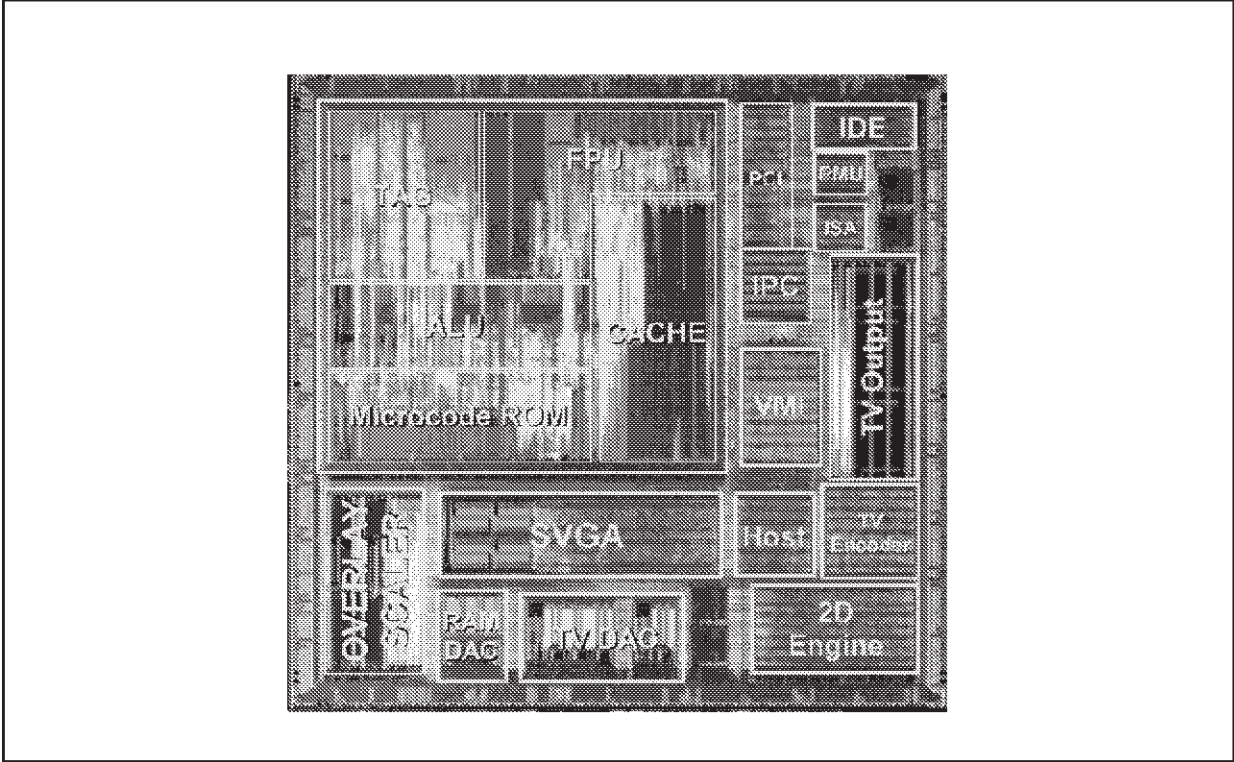
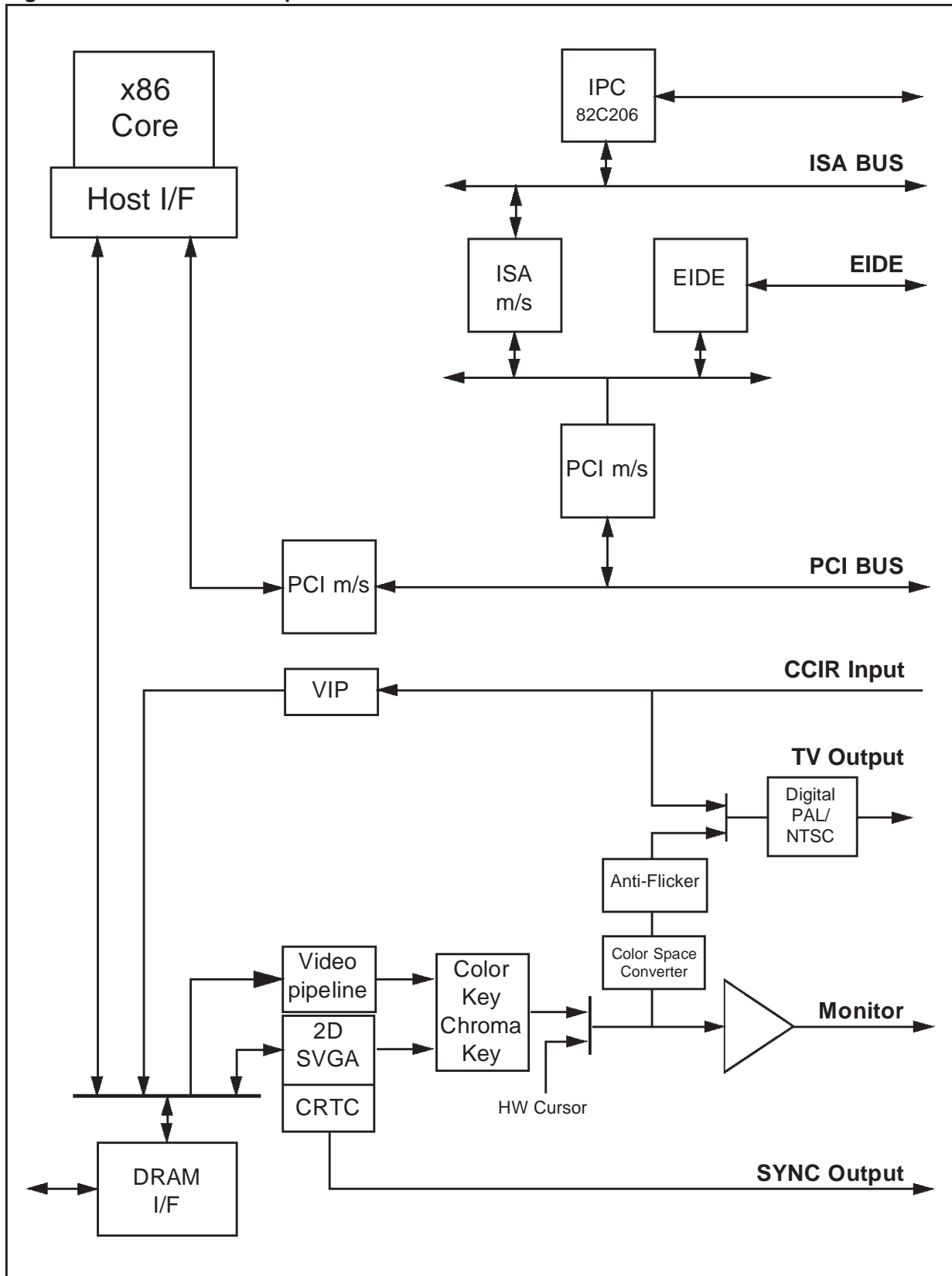


Figure 4. Functionnal description.



GENERAL DESCRIPTION

Figure 5. Pictorial Block Diagram

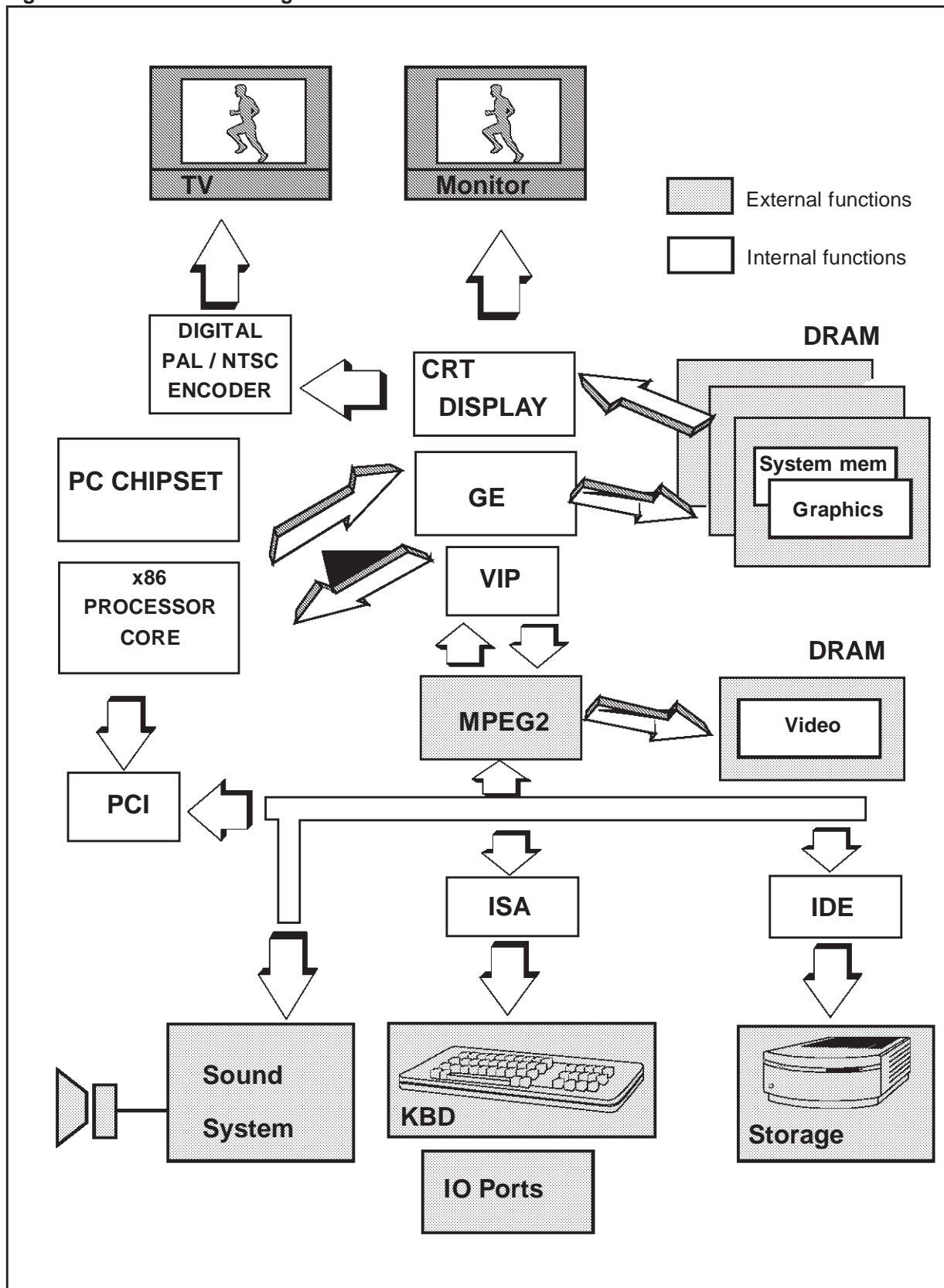
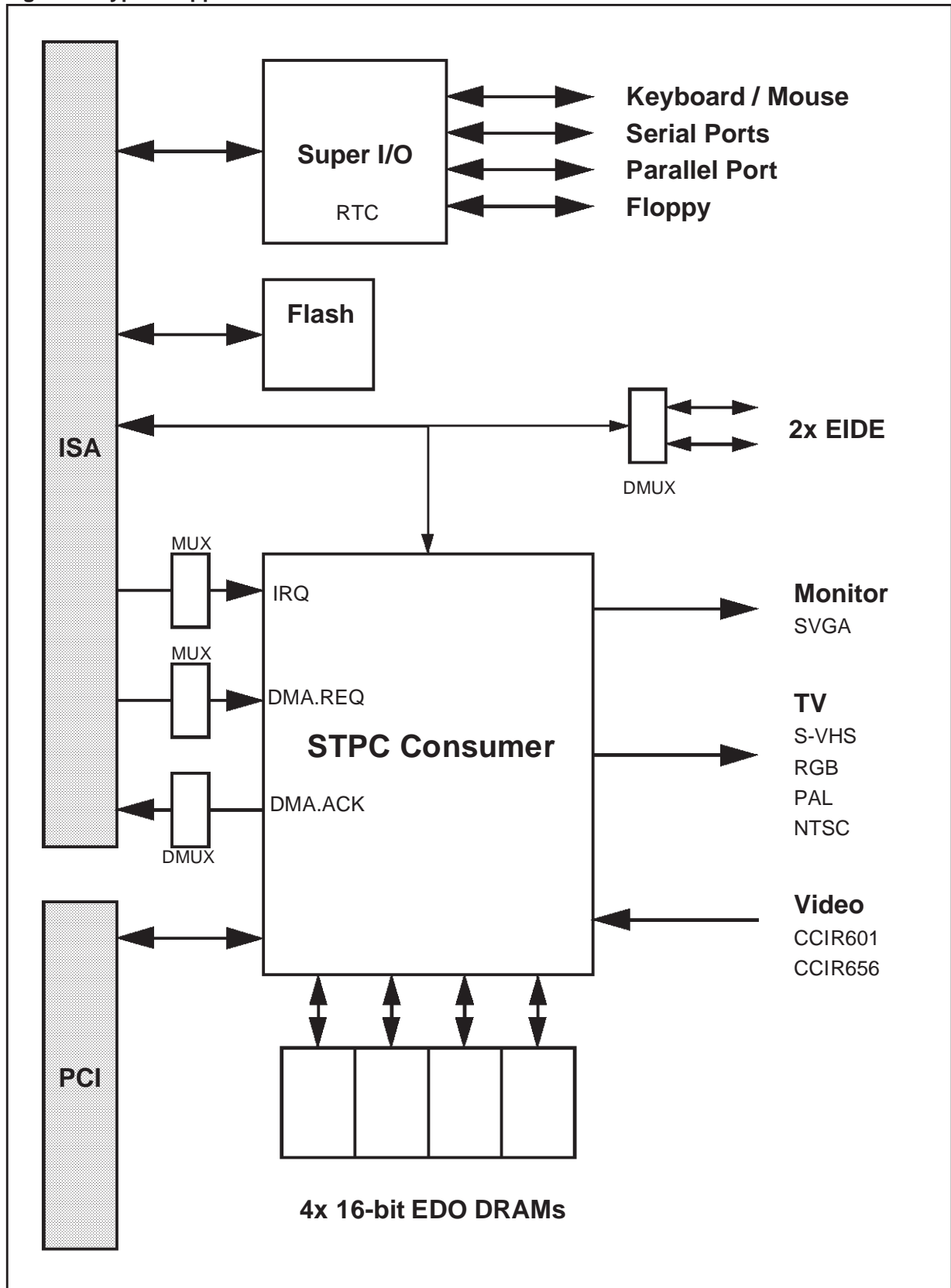


Figure 6. Typical Application



2 PIN DESCRIPTION

2.1 INTRODUCTION

The STPC Consumer integrates most of the functionalities of the PC architecture. As a result, many of the traditional interconnections between the host PC microprocessor and the peripheral devices are totally internal to the STPC Consumer. This offers improved performance due to the tight coupling of the processor core and these peripherals. As a result many of the external pin connections are made directly to the on-chip peripheral functions.

Figure 7 shows the STPC Consumer's external interfaces. It defines the main busses and their function. Table 1 describes the physical implementation listing signals type and their functionality. Table 2 provides a full pin listing and description of pins. Table 3 provides a full listing of pin locations of the STPC Consumer package by physical connection. Please refer to the pin allocation drawing for reference.

Table 1. Signal Description

Group name	Qty
Basic Clocks reset & Xtal	7
Memory Interface	89
PCI interface	56
ISA / IDE / IPC combined interface	91
Video Input	9
TV Output	12
VGA Monitor interface	10
Grounds	69
V _{DD}	28
Analog specific V _{CC} /V _{DD}	14
Reserved	5
Total Pin Count	388

Note: Several interface pins are multiplexed with other functions, refer to the Pin Description section for further details

Figure 7. PC Consumer External Interfaces

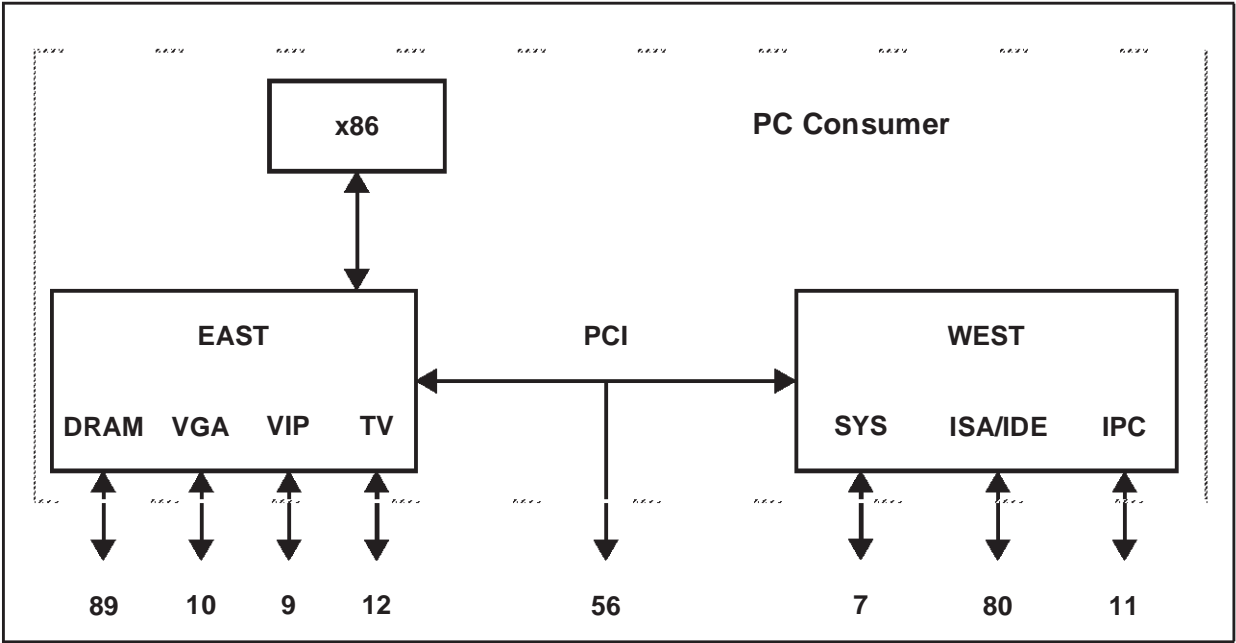


Table 2. Definition of Signal Pins

Signal Name	Dir	Description	Qty
BASIC CLOCKS AND RESETS			
PWERGD	I	System Reset / Power good	1
XTALI	I	14.3MHz Crystal Input	1
XTALO	I/O	14.3MHz Crystal Output - External Oscillator Input	1
HCLK	O	Host Clock (Test)	1
DEV_CLK	O	24MHz Peripheral Clock (floppy drive)	1
GCLK2X	I/O	80MHz Graphics Clock	1
DCLK	I/O	135MHz Dot Clock	1
MEMORY INTERFACE			
MA[11:0]	I/O	Memory Address	12
RAS#[3:0]	O	Row Address Strobe	4
CAS#[7:0]	O	Column Address Strobe	8
MWE#	O	Write Enable	1
MD[63:0]	I/O	Memory Data	64
PCI INTERFACE			
PCI_CLKI	I	33MHz PCI Input Clock	1
PCI_CLKO	O	33MHz PCI Output Clock (from internal PLL)	1
AD[31:0]	I/O	PCI Address / Data	32
CBE[3:0]	I/O	Bus Commands / Byte Enables	4
FRAME#	I/O	Cycle Frame	1
TRDY#	I/O	Target Ready	1
IRDY#	I/O	Initiator Ready	1
STOP#	I/O	Stop Transaction	1
DEVSEL#	I/O	Device Select	1
PAR	I/O	Parity Signal Transactions	1
SERR#	O	System Error	1
LOCK#	I	PCI Lock	1
PCIREQ#[2:0]	I	PCI Request	3
PCIGNT#[2:0]	O	PCI Grant	3
PCI_INT[3:0]	I	PCI Interrupt Request	4
ISA AND IDE COMBINED ADDRESS/DATA			
LA[23:22] / SCS3#,SCS1#	I/O	Unlatched Address (ISA) / Secondary Chip Select (IDE)	2
LA[21:20] / PCS3#,PCS1#	I/O	Unlatched Address (ISA) / Primary Chip Select (IDE)	2
LA[19:17] / DA[2:0]	O	Unlatched Address (ISA) / Address (IDE)	3
RMRTCCS# / DD[15]	I/O	ROM/RTC Chip Select / Data Bus bit 15 (IDE)	1
KBCS# / DD[14]	I/O	Keyboard Chip Select / Data Bus bit 14 (IDE)	1
RTCRW# / DD[13]	I/O	RTC Read/Write / Data Bus bit 13 (IDE)	1
RTCDs# / DD[12]	I/O	RTC Data Strobe / Data Bus bit 12 (IDE)	1
SA[19:8] / DD[11:0]	I/O	Latched Address (ISA) / Data Bus (IDE)	16
SA[7:0]	I/O	Latched Address (IDE)	4
SD[15:0]	I/O	Data Bus (ISA)	16
ISA/IDE COMBINED CONTROL			
IOCHRDY / DIORDY	I/O	I/O Channel Ready (ISA) - Busy/Ready (IDE)	1

PIN DESCRIPTION

Table 2. Definition of Signal Pins

Signal Name	Dir	Description	Qty
ISA CONTROL			
SYSRSTO#	O	Reset Output to System	1
ISA_CLK	O	ISA Clock Output - Multiplexer Select Line For IPC	1
ISA_CLK2X	O	ISA Clock x 2 Output - Multiplexer Select Line For IPC	1
OSC14M	O	ISA bus synchronisation clock	1
ALE	O	Address Latch Enable	1
BHE#	I/O	System Bus High Enable	1
MEMR#, MEMW#	I/O	Memory Read and Memory Write	2
SMEMR#, SMEMW#	O	System Memory Read and Memory Write	2
IOR#, IOW#	I/O	I/O Read and Write	2
MASTER#	I	Add On Card Owns Bus	1
MCS16#, IOCS16#	I	Memory/IO Chip Select16	2
REF#	O	Refresh Cycle.	1
AEN	O	Address Enable	1
ZWS#	I	Zero Wait State	1
IOCHCK#	I	I/O Channel Check.	1
ISAOE#	O	Bidirectional OE Control	1
RTCAS#	O	Real Time Clock Address Strobe	1
GPIOCS#	I/O	General Purpose Chip Select	1
IDE CONTROL			
PIRQ	I	Primary Interrupt Request	1
SIRQ	I	Secondary Interrupt Request	1
PDRQ	I	Primary DMA Request	1
SDRQ	I	Secondary DMA Request	1
PDACK#	O	Primary DMA Acknowledge	1
SDACK#	O	Secondary DMA Acknowledge	1
PIOR#	I/O	Primary I/O Read	1
PIOW#	O	Primary I/O Write	1
SIOR#	I/O	Secondary I/O Read	1
SIOW#	O	Secondary I/O Write	1
IPC			
IRQ_MUX[3:0]	I	Multiplexed Interrupt Request	4
DREQ_MUX[1:0]	I	Multiplexed DMA Request	2
DACK_ENC[2:0]	O	DMA Acknowledge	3
TC	O	ISA Terminal Count	1
SPKRD	O	Speaker Device Output	1
MONITOR INTERFACE			
RED, GREEN, BLUE	O	Red, Green, Blue	3
VSYNC	O	Vertical Sync	1
HSYNC	O	Horizontal Sync	1
VREF_DAC	I	DAC Voltage reference	1
RSET	I	Resistor Set	1
COMP	I	Compensation	1
DDC[1:0]	I/O	Display Data Channel Serial Link	2

Table 2. Definition of Signal Pins

Signal Name	Dir	Description	Qty
VIDEO INPUT			
VCLK	I	Pixel Clock	1
VIN	I	YUV Video Data Input CCIR 601 or 656	8
DIGITAL TV OUTPUT			
RED_TV, GREEN_TV, BLUE_TV	O	Analog video outputs synchronized with CVBS	3
VCS	O	Composite Synch or Horizontal line SYNC output	1
ODD_EVEN	O	Frame Synchronisation	1
CVBS	O	Analog video composite output (luminance / chrominance)	1
IREF1_TV	I	Reference current of 9bit DAC for CVBS	1
VREF1_TV	I	Reference voltage of 9bit DAC for CVBS	1
IREF2_TV	I	Reference current of 8bit DAC for R,G,B	1
VREF2_TV	I	Reference voltage of 8bit DAC for R,G,B	1
VSSA_TV	I	Analog Vss for DAC	1
VDDA_TV	I	Analog Vdd for DAC	1
MISCELLANEOUS			
SCAN_ENABLE	I	Reserved (Test pin)	1

PIN DESCRIPTION

2.2 SIGNAL DESCRIPTIONS

2.2.1 BASIC CLOCKS AND RESETS

PWGD *System Reset/Power good.* This input is low when the the reset switch is depressed. Otherwise, it reflects the power supply's power good signal. PWGD is asynchronous to all clocks, and acts as a negative active reset. The reset circuit initiates a hard reset on the rising edge of PWGD.

SYSRSTO# *Reset Output to System.* This is the system reset signal and is used to reset the rest of the components (not on Host bus) in the system. The ISA bus reset is an externally inverted buffered version of this output and the PCI bus reset is an externally buffered version of this output.

XTALI *14.3MHz Crystal Input*

XTALO *14.3MHz Crystal Output.* These pins are the 14.318 MHz crystal input; This clock is used as the reference clock for the internal frequency synthesizer to generate the HCLK, CLK24M, GCLK2X and DCLK clocks.

A 14.318 MHz Series Cut Quartz Crystal should be connected between these two pins. Balance capacitors of 15 pF should also be added. In the event of an external oscillator providing the master clock signal to the STPC Consumer device, the TTL signal should be provided on XTALO.

HCLK *Host Clock.* This is the host 1X clock. Its frequency can vary from 25 to 75 MHz. All host transactions and PCI transactions are synchronized to this clock. The DRAM controller to execute the host transactions is also driven by this clock. In normal mode, this output clock is generated by the internal pll.

GCLK2X *80MHz Graphics Clock.* This is the Graphics 2X clock, which drives the graphics engine and the the DRAM controller to execute the graphics and display cycles.

Normally GCLK2X is generated by the internal frequency synthesizer, and this pin is an output. By setting a bit in Strap Register 2, this pin can be made an input so that an external clock can replace the internal frequency synthesizer.

PCI_CLKI *33MHz PCI Input Clock*

This signal is the PCI bus clock input and should be driven from the PCI_CLKO pin.

PCI_CLKO *33MHz PCI Output Clock.* This is the master PCI bus clock output.

DCLK *135MHz Dot Clock.* This is the dot clock, which drives graphics display cycles. Its frequency can be as high as 135 MHz, and it is required to have a worst case duty cycle of 60-40.

This signal is either driven by the internal pll (VGA) either by an external 27MHz oscillator (TV). The direction can be controlled by a strap option or an internal register bit.

DISA_CLK *ISA Clock Output (also Multiplexer Select Line For IPC).* This pin produces the Clock signal for the ISA bus. It is also used with ISA_CLK2X as the multiplexor control lines for the Interrupt Controller Interrupt input lines. This is divided down version of either the PCICLK or OSC14M.

ISA_CLKX2 *ISA Clock Output (also Multiplexer Select Line For IPC).* This pin produces a signal at twice the frequency of the Clock signal for the ISA bus. It is also used with ISA_CLK as the multiplexor control lines for the Interrupt Controller Interrupt input lines.

DEV_CLK *24MHz Peripheral Clock Output.* This 24MHZ signal is provided as a convenience for the system integration of a Floppy Disk driver function in an external chip.

OSC14M *ISA bus synchronisation clock Output.* This is the buffered 14.318 Mhz clock to the ISA bus.

2.2.2 MEMORY INTERFACE

MA[11:0] *Memory Address Output.* These 12 multiplexed memory address pins support external DRAM with up to 4K refresh. These include all 16M x N and some 4M x N DRAM modules. The address signals must be externally buffered to support more than 16 DRAM chips. The timing of these signals can be adjusted by software to match the timings of most DRAM modules.

MD[63:0] *Memory Data I/O.* This is the 64-bit memory data bus. If only half of a bank is populated, MD63-32 is pulled high, data is on MD31-0. MD[40-0] are read by the device strap option registers during rising edge of PWGD.

RAS#[3:0] *Row Address Strobe Output.* There are 4 active low row address strobe outputs, one each for each bank of the memory. Each bank contains 4 or 8-bytes of data. The memory controller allows half of a bank (4-bytes) to be populated to enable memory upgrade at finer granularity. The RAS# signals drive the SIMMs directly without any external buffering. These pins are always outputs, but they can also simultaneously be inputs, to allow the memory controller to monitor the value of the RAS# signals at the pins.

CAS#[7:0] *Column Address Strobe Output.* There are 8 active low column address strobe outputs, one each for each byte of the memory. The CAS# signals drive the SIMMs either directly or through external buffers. These pins are always outputs, but they can also simultaneously be inputs, to allow the memory controller to monitor the value of the CAS# signals at the pins.

MWE# *Write Enable Output.* Write enable specifies whether the memory access is a read (MWE# = H) or a write (MWE# = L). This single write enable controls all DRAMs. It can be externally buffered to boost the maximum number of loads (DRAM chips) supported. The MWE# signals drive the SIMMs directly without any external buffering.

2.2.3 VIDEO INTERFACE

VCLK *Pixel Clock Input.*

VIN[7:0] *YUV Video Data Input CCIR 601 or 656.* Time multiplexed 4:2:2 luminance and chrominance data as defined in ITU-R Rec601-2 and Rec656 (except for TTL input levels). This bus interfaces with an MPEG video decoder output port and typically carries a stream of Cb,Y,Cr,Y digital video at VCLK frequency, clocked on the rising edge (by default) of VCLK. A 54-Mbit/s 'double' Cb, Y, Cr, Y input multiplex is supported for double encoding application (rising and falling edge of CKREF are operating).

2.2.4 TV OUTPUT

RED_TV / C_TV *Analog video outputs synchronized with CVBS.* This output is current-driven and must be connected to analog ground over a load resistor (R_{LOAD}). Following the load resistor, a simple analog low pass filter is recommended. In S-VHS mode, this is the Chrominance Output.

GREEN_TV / Y_TV *Analog video outputs synchronized with CVBS.* This output is current-driven and must be connected to analog ground over a load resistor (R_{LOAD}). Following the load resistor, a simple analog low pass filter is recommended. In S-VHS mode, this is the Luminance Output.

BLUE_TV / CVBS *Analog video outputs synchronized with CVBS.* This output is current-driven and must be connected to analog ground over a load resistor (R_{LOAD}). Following the load resistor, a simple analog low pass filter is recommended. In S-VHS mode, this is a second composite output.

VCS *Line synchronisation Output.* This pin is an input in ODDEV+HSYNC or VSYNC + HSYNC or VSYNC slave modes and an output in all other modes (master/slave). The signal is synchronous to rising edge of CK-REF. The default polarity uses a negative pulse

ODD_EVEN *Frame Synchronisation Output.* This pin supports the Frame synchronisation signal. It is an input in slave modes, except when sync is extracted from YCrCb data, and an output in master mode and when sync is extracted from YCrCb data. The signal is synchronous to rising edge of DCLK. The default polarity for this pin is:
- odd (not-top) field : LOW level
- even (bottom) field : HIGH level

IREF1_TV *Ref. current for CVBS 10-bit DAC.*

VREF1_TV *Ref. voltage for CVBS 10-bit DAC.*

IREF2_TV *Reference current for RGB 9-bit DAC.*

VREF2_TV *Reference voltage for RGB 9-bit DAC.*

VSSA_TV *Analog V_{SS} for DAC*

VDDA_TV *Analog V_{DD} for DAC*

PIN DESCRIPTION

CVBS *Analog video composite output (luminance/chrominance).* CVBS is current-driven and must be connected to analog ground over a load resistor (R_{LOAD}). Following the load resistor, a simple analog low pass filter is recommended.

2.2.5 PCI INTERFACE

AD[31:0] *PCI Address/Data.* This is the 32-bit multiplexed address and data bus of the PCI. This bus is driven by the master during the address phase and data phase of write transactions. It is driven by the target during data phase of read transactions.

CBE#[3:0] *Bus Commands/Byte Enables.* These are the multiplexed command and byte enable signals of the PCI bus. During the address phase they define the command and during the data phase they carry the byte enable information. These pins are inputs when a PCI master other than the STPC Consumer owns the bus and outputs when the STPC Consumer owns the bus.

FRAME# *Cycle Frame.* This is the frame signal of the PCI bus. It is an input when a PCI master owns the bus and is an output when STPC Consumer owns the PCI bus.

TRDY# *Target Ready.* This is the target ready signal of the PCI bus. It is driven as an output when the STPC Consumer is the target of the current bus transaction. It is used as an input when STPC Consumer initiates a cycle on the PCI bus.

IRDY# *Initiator Ready.* This is the initiator ready signal of the PCI bus. It is used as an output when the STPC Consumer initiates a bus cycle on the PCI bus. It is used as an input during the PCI cycles targeted to the STPC Consumer to determine when the current PCI master is ready to complete the current transaction.

STOP# *Stop Transaction.* Stop is used to implement the disconnect, retry and abort protocol of the PCI bus. It is used as an input for the bus cycles initiated by the STPC Consumer and is used as an output when a PCI master cycle is targeted to the STPC Consumer.

DEVSEL# *I/O Device Select.* This signal is used as an input when the STPC Consumer initiates a bus cycle on the PCI bus to determine if a PCI slave device has decoded itself to be the target of

the current transaction. It is asserted as an output either when the STPC Consumer is the target of the current PCI transaction or when no other device asserts DEVSEL# prior to the subtractive decode phase of the current PCI transaction.

PAR *Parity Signal Transactions.* This is the parity signal of the PCI bus. This signal is used to guarantee even parity across AD[31:0], CBE#[3:0], and PAR. This signal is driven by the master during the address phase and data phase of write transactions. It is driven by the target during data phase of read transactions. (Its assertion is identical to that of the AD bus delayed by one PCI clock cycle)

SERR# *System Error.* This is the system error signal of the PCI bus. It may, if enabled, be asserted for one PCI clock cycle if target aborts a STPC Consumer initiated PCI transaction. Its assertion by either the STPC Consumer or by another PCI bus agent will trigger the assertion of NMI to the host CPU. This is an open drain output.

LOCK# *PCI Lock.* This is the lock signal of the PCI bus and is used to implement the exclusive bus operations when acting as a PCI target agent.

PCIREQ#[2:0] *PCI Request.* This pin are the three external PCI master request pins. They indicate to the PCI arbiter that the external agents desire use of the bus.

PCIGNT#[2:0] *PCI Grant.* These pins indicate that the PCI bus has been granted to the master requesting it on its PCIREQ#.

2.2.6 ISA/IDE COMBINED ADDRESS/DATA

LA[23]/SCS3# *Unlatched Address (ISA)/Secondary Chip Select (IDE).* This pin has two functions, depending on whether the ISA bus is active or the IDE bus is active.

When the ISA bus is active, this pins is ISA Bus unlatched address bit 23 for 16-bit devices. When ISA bus is accessed by any cycle initiated from PCI bus, this pin is in output mode. When an ISA bus master owns the bus, this pins is in input mode.

When the IDE bus is active, this signals is used as the active high secondary slave IDE chip select signal. This signal is to be externally NANDed with the ISAOE# signal before driving the IDE devices to guarantee it is active only when ISA bus is idle.

LA[22]/SCS1# *Unlatched Address (ISA)/Secondary Chip Select (IDE)*

This pin has two functions, depending on whether the ISA bus is active or the IDE bus is active.

When the ISA bus is active, this pin is ISA Bus unlatched address bit 22 for 16-bit devices. When ISA bus is accessed by any cycle initiated from PCI bus, this pin is in output mode. When an ISA bus master owns the bus, this pin is in input mode.

When the IDE bus is active, this signal is used as the active high secondary slave IDE chip select signal. This signal is to be externally ANDed with the ISAOE# signal before driving the IDE devices to guarantee it is active only when ISA bus is idle.

LA[21]/PCS3# *Unlatched Address (ISA)/Primary Chip Select (IDE)*. This pin has two functions, depending on whether the ISA bus is active or the IDE bus is active.

When the ISA bus is active, this pin is ISA Bus unlatched address bit 21 for 16-bit devices. When ISA bus is accessed by any cycle initiated from PCI bus, this pin is in output mode. When an ISA-bus master owns the bus, this pin is in input mode.

When the IDE bus is active, this signal is used as the active high primary slave IDE chip select signal. This signal is to be externally NANDed with the ISAOE# signal before driving the IDE devices to guarantee it is active only when ISA bus is idle.

LA[20]/PCS1# *Unlatched Address (ISA)/Primary Chip Select (IDE)*. This pin has two functions, depending on whether the ISA bus is active or the IDE bus is active.

When the ISA bus is active, this pin is ISA Bus unlatched address bit 20 for 16-bit devices. When ISA bus is accessed by any cycle initiated from PCI bus, this pin is in output mode. When an ISA bus master owns the bus, this pin is in input mode.

When the IDE bus is active, this signal is used as the active high primary slave IDE chip select signal. This signal is to be externally NANDed with the ISAOE# signal before driving the IDE devices to guarantee it is active only when ISA bus is idle.

LA[19:17]/DA[2:0] *Unlatched Address (ISA)/Address (IDE)*. These pins are multi-function pins. They are used as the ISA bus unlatched address bits [19:17] for ISA bus or the three address bits for the IDE bus devices.

When used by the ISA bus, these pins are ISA Bus unlatched address bits 19-17 on 16-bit devices. When ISA bus is accessed by any cycle initiated from the PCI bus, these pins are in output mode. When an ISA bus master owns the bus, these pins are tristated.

For IDE devices, these signals are used as the DA[2:0] and are connected to DA[2:0] of IDE devices directly or through a buffer. If the toggling of signals are to be masked during ISA bus cycles, they can be externally ORed before being connected to the IDE devices.

SA[19:8]/DD[11:0] *Unlatched Address (ISA)/Data Bus (IDE)*. These are multifunction pins. When the ISA bus is active, they are used as the ISA bus system address bits 19-8. When the IDE bus is active, they serve as IDE signals DD[11:0].

These pins are used as an input when an ISA bus master owns the bus and are outputs at all other times.

IDE devices are connected to SA[19:8] directly and ISA bus is connected to these pins through two LS245 transceivers. The OE of the transceivers are connected to ISAOE# and DIR is connected to MASTER#. A bus signals of the transceivers are connected to CPC and IDE DD bus and B bus signals are connected to ISA SA bus.

DD[15:12] *Databus (IDE)*. The high 4 bits of the IDE databus are combined with several of the X-bus lines. Refer to the following section for X-bus pins for further information.

SA[7:0] *ISA Bus address bits [7:0]*. These are the 8 low bits of the system address bus of ISA on 8-bit slot. These pins are used as an input when an ISA bus master owns the bus and are outputs at all other times.

SD[15:0] *I/O Data Bus (ISA)*. These pins are the external databus to the ISA bus.

PIN DESCRIPTION

2.2.7 ISA/IDE COMBINED CONTROL

IOCHRDY/DIORDY *Channel Ready (ISA)/Busy/Ready (IDE)*. This is a multi-function pin. When the ISA bus is active, this pin is IOCHRDY. When the IDE bus is active, this serves as IDE signal DIORDY.

IOCHRDY is the IO channel ready signal of the ISA bus and is driven as an output in response to an ISA master cycle targeted to the host bus or an internal register of the STPC Consumer. The STPC Consumer monitors this signal as an input when performing an ISA cycle on behalf of the host CPU, DMA master or refresh.

ISA masters which do not monitor IOCHRDY are not guaranteed to work with the STPC Consumer since the access to the system memory can be considerably delayed due to CRT refresh or a write back cycle.

2.2.8 ISA CONTROL

ALE *Address Latch Enable*. This is the address latch enable output of the ISA bus and is asserted by the STPC Consumer to indicate that LA23-17, SA19-0, AEN and SBHE# signals are valid. The ALE is driven high during refresh, DMA master or an ISA master cycles by the STPC Consumer. ALE is driven low after reset.

BHE# *System Bus High Enable*. This signal, when asserted, indicates that a data byte is being transferred on SD15-8 lines. It is used as an input when an ISA master owns the bus and is an output at all other times.

MEMR# *Memory Read*. This is the memory read command signal of the ISA bus. It is used as an input when an ISA master owns the bus and is an output at all other times.
The MEMR# signal is active during refresh.

MEMW# *Memory Write*. This is the memory write command signal of the ISA bus. It is used as an input when an ISA master owns the bus and is an output at all other times.

SMEMR# *System Memory Read*. The STPC Consumer generates SMEMR# signal of the ISA bus only when the address is below one megabyte or the cycle is a refresh cycle.

SMEMW# *System Memory Write*. The STPC Consumer generates SMEMW# signal of the ISA bus only when the address is below one megabyte.

IOR# *I/O Read*. This is the IO read command signal of the ISA bus. It is an input when an ISA master owns the bus and is an output at all other times.

IOW# *I/O Write*. This is the IO write command signal of the ISA bus. It is an input when an ISA master owns the bus and is an output at all other times.

MASTER# *Add On Card Owns Bus*. This signal is active when an ISA device has been granted bus ownership.

MCS16# *Memory Chip Select16*. This is the decode of LA23-17 address pins of the ISA address bus without any qualification of the command signal lines. MCS16# is always an input. The STPC Consumer ignores this signal during IO and refresh cycles.

IOCS16# *IO Chip Select16*. This signal is the decode of SA15-0 address pins of the ISA address bus without any qualification of the command signals. The STPC Consumer does not drive IOCS16# (similar to PC-AT design). An ISA master access to an internal register of the STPC Consumer is executed as an extended 8-bit IO cycle.

REF# *Refresh Cycle*. This is the refresh command signal of the ISA bus. It is driven as an output when the STPC Consumer performs a refresh cycle on the ISA bus. It is used as an input when an ISA master owns the bus and is used to trigger a refresh cycle.

The STPC Consumer performs a pseudo hidden refresh. It requests the host bus for two host clocks to drive the refresh address and capture it in external buffers. The host bus is then relinquished while the refresh cycle continues on the ISA bus.

AEN *Address Enable*. Address Enable is enabled when the DMA controller is the bus owner to indicate that a DMA transfer will occur. The enabling of the signal indicates to IO devices to ignore the IOR#/IOW# signal during DMA transfers.

ZWS# *Zero Wait State.* This signal, when asserted by addressed device, indicates that current cycle can be shortened.

IOCHCK# *IO Channel Check.* IO Channel Check is enabled by any ISA device to signal an error condition that can not be corrected. NMI signal becomes active upon seeing IOCHCK# active if the corresponding bit in Port B is enabled.

ISAOE# *Bidirectional OE Control.* This signal controls the OE signal of the external transceiver that connects the IDE DD bus and ISA SA bus.

GPIOCS# *I/O General Purpose Chip Select 1.* This output signal is used by the external latch on ISA bus to latch the data on the SD[7:0] bus. The latch can be use by PMU unit to control the external peripheral devices to power down or any other desired function. This pin is also serves as a strap input during reset.

2.2.9 IDE CONTROL

PIRQ *Primary Interrupt Request.* Interrupt request from primary IDE channel.

SIRQ *Secondary Interrupt Request.* Interrupt request from secondary IDE channel.

PDRQ *Primary DMA Request.* DMA request from primary IDE channel.

SDRQ *Secondary DMA Request.* DMA request from secondary IDE channel.

PDACK# *Primary DMA Acknowledge.* DMA acknowledge to primary IDE channel.

SDACK# *Secondary DMA Acknowledge.* DMA acknowledge to secondary IDE channel.

PIOR# *Primary I/O Read.* Primary channel read. Active low output.

PIOW# *Primary I/O Write.* Primary channel write. Active low output.

SIOR# *Secondary I/O Read* Secondary channel read. Active low output.

SIOW# *Secondary I/O Write* Secondary channel write. Active low output.

2.2.10 IPC

IRQ_MUX[3:0] *Multiplexed Interrupt Request.* These are the ISA bus interrupt signals. They are to be encoded before connection to the STPC Consumer using ISACLK and ISACLKX2 as the input selection strobes.

Note that IRQ8B, which by convention is connected to the RTC, is inverted before being sent to the interrupt controller, so that it may be connected directly to the $\overline{\text{IRQ}}$ pin of the RTC.

PCI_INT[3:0] *PCI Interrupt Request.* These are the PCI bus interrupt signals. They are to be encoded before connection to the STPC Consumer using ISACLK and ISACLKX2 as the input selection strobes.

DREQ_MUX[1:0] *ISA Bus Multiplexed DMA Request.* These are the ISA bus DMA request signals. They are to be encoded before connection to the STPC Consumer using ISACLK and ISACLKX2 as the input selection strobes.

DACK_ENC[2:0] *DMA Acknowledge.* These are the ISA bus DMA acknowledge signals. They are encoded by the STPC Consumer before output and should be decoded externally using ISACLK and ISACLKX2 as the control strobes.

TC *ISA Terminal Count.* This is the terminal count output of the DMA controller and is connected to the TC line of the ISA bus. It is asserted during the last DMA transfer, when the byte count expires.

SPKRD *Speaker Drive.* This the output to the speaker and is AND of the counter 2 output with bit 1 of Port 61, and drives an external speaker driver. This output should be connected to 7407 type high voltage driver.

PIN DESCRIPTION

2.2.11 X-Bus Interface pins / IDE Data

RMRTCCS# / DD[15] *ROM/Real Time clock chip select.* This pin is a multi-function pin. When ISAOE# is active, this signal is used as RMRTCCS#. This signal is asserted if a ROM access is decoded during a memory cycle. It should be combined with MEMR# or MEMW# signals to properly access the ROM. During a IO cycle, this signal is asserted if access to the Real Time Clock (RTC) is decoded. It should be combined with IOR or IOW# signals to properly access the real time clock.

When ISAOE# is inactive, this signal is used as IDE DD[15] signal.

This signal must be ORed externally with ISAOE# and is then connected to ROM and RTC. An LS244 or equivalent function can be used if OE# is connected to ISAOE# and the output is provided with a weak pull-up resistor.

KBCS# / DD[14] *Keyboard Chip Select.* This pin is a multi-function pin. When ISAOE# is active, this signal is used as KBCS#. This signal is asserted if a keyboard access is decoded during a I/O cycle.

When ISAOE# is inactive, this signal is used as IDE DD[14] signal.

This signal must be ORed externally with ISAOE# and is then connected to keyboard. An LS244 or equivalent function can be used if OE# is connected to ISAOE# and the output is provided with a weak pull-up resistor.

RTCRW# / DD[13] *Real Time Clock \overline{RW} .* This pin is a multi-function pin. When ISAOE# is active, this signal is used as RTCRW#. This signal is asserted for any I/O write to port 71H.

When ISAOE# is inactive, this signal is used as IDE DD[13] signal.

This signal must be ORed externally with ISAOE# and then connected to the RTC. An LS244 or equivalent function can be used if OE is connected to ISAOE# and the output is provided with a weak pull-up resistor.

RTCDS# / DD[12] *Real Time Clock DS* This pin is a multi-function pin. When ISAOE# is active, this signal is used as RTCDS. This signal is asserted for any I/O read to port 71H.

When ISAOE# is inactive, this signal is used as IDE DD[12] signal.

This signal must be ORed externally with ISAOE# and is then connected to RTC. An LS244 or equivalent function can be used if OE# is connected to ISAOE# and the output is provided with a weak pull-up resistor.

RTCAS# *Real time clock address strobe.* This signal is asserted for any I/O write to port 70H.

2.2.12 Monitor Interface

RED, GREEN, BLUE *RGB Video Outputs.* These are the 3 analog color outputs from the RAMDACs

VSYSN *Vertical Synchronisation Pulse.* This is the vertical synchronization signal from the VGA controller.

HSYSN *Horizontal Synchronisation Pulse.* This is the horizontal synchronization signal from the VGA controller.

VREF_DAC *DAC Voltage reference.* An external voltage reference is connected to this pin to bias the DAC.

RSET *Resistor Current Set.* This is reference current input to the RAMDAC is used to set the full-scale output of the RAMDAC.

COMP *Compensation.* This is the RAMDAC compensation pin. Normally, an external capacitor (typically 10nF) is connected between this pin and V_{DD} to damp oscillations.

DDC[1:0] *Direct Data Channel Serial Link.* These bidirectional pins are connected to CRTC register 3Fh to implement DDC capabilities. They conform to I²C electrical specifications, they have open-collector output drivers which are internally connected to V_{DD} through pull-up resistors.

2.2.13 MISCELLANEOUS

SCAN_ENABLE *Reserved.* The pins are reserved for Test and Miscellaneous functions)

Table 3. Pinout.

Pin #	Pin name	Pin #	Pin name	Pin #	Pin name
AF3	PWERGD	U24	MD[16]	D25	PCI_CLKO
A3	XTALI	R26	MD[17]	A20	AD[0]
C4	XTALO	P25	MD[18]	C20	AD[1]
G23	HCLK	P26	MD[19]	B19	AD[2]
F25	DEV_CLK	N25	MD[20]	A19	AD[3]
AF15	GCLK2X	N26	MD[21]	C19	AD[4]
AF9	DCLK	M25	MD[22]	B18	AD[5]
AD15	MA[0]	M26	MD[23]	A18	AD[6]
AF16	MA[1]	M24	MD[24]	B17	AD[7]
AC15	MA[2]	M23	MD[25]	C18	AD[8]
AE17	MA[3]	L24	MD[26]	A17	AD[9]
AD16	MA[4]	J25	MD[27]	D17	AD[10]
AF17	MA[5]	J26	MD[28]	B16	AD[11]
AC17	MA[6]	H26	MD[29]	C17	AD[12]
AE18	MA[7]	G25	MD[30]	B15	AD[13]
AD17	MA[8]	G26	MD[31]	A15	AD[14]
AF18	MA[9]	AD22	MD[32]	C16	AD[15]
AE19	MA[10]	AD23	MD[33]	D15	AD[16]
AF19	MA[11]	AE26	MD[34]	A14	AD[17]
AD18	RAS#[0]	AD26	MD[35]	C15	AD[18]
AE20	RAS#[1]	AC24	MD[36]	B13	AD[19]
AC19	RAS#[2]	AB25	MD[37]	D13	AD[20]
AF20	RAS#[3]	AB26	MD[38]	A13	AD[21]
AE21	CAS#[0]	Y23	MD[39]	C14	AD[22]
AC20	CAS#[1]	AA26	MD[40]	C13	AD[23]
AF21	CAS#[2]	Y26	MD[41]	A12	AD[24]
AD20	CAS#[3]	W25	MD[42]	B11	AD[25]
AE22	CAS#[4]	W26	MD[43]	C12	AD[26]
AF22	CAS#[5]	V25	MD[44]	A11	AD[27]
AD21	CAS#[6]	U25	MD[45]	D12	AD[28]
AE23	CAS#[7]	U26	MD[46]	B10	AD[29]
AC22	MWE#	T25	MD[47]	C11	AD[30]
AF23	MD[0]	R25	MD[48]	A10	AD[31]
AE24	MD[1]	T24	MD[49]	D10	CBE[0]
AF24	MD[2]	R23	MD[50]	C10	CBE[1]
AD25	MD[3]	R24	MD[51]	A9	CBE[2]
AC25	MD[4]	N23	MD[52]	B8	CBE[3]
AC26	MD[5]	P24	MD[53]	A8	FRAME#
AB24	MD[6]	N24	MD[54]	B7	TRDY#
AA25	MD[7]	L25	MD[55]	D8	IRDY#
AA24	MD[8]	L26	MD[56]	A7	STOP#
Y25	MD[9]	K25	MD[57]	C8	DEVSEL#
Y24	MD[10]	K26	MD[58]	B6	PAR
V23	MD[11]	K24	MD[59]	D7	SERR#
W24	MD[12]	H25	MD[60]	A6	LOCK#
V26	MD[13]	J24	MD[61]	C21	PCI_REQ#[0]
V24	MD[14]	H23	MD[62]	A21	PCI_REQ#[1]
U23	MD[15]	H24	MD[63]	B20	PCI_REQ#[2]
		F24	PCI_CLKI	C22	PCI_GNT#[0]

PIN DESCRIPTION

Pin #	Pin name
B21	PCI_GNT#[1]
D20	PCI_GNT#[2]
A5	PCI_INT[0]
C6	PCI_INT[1]
B4	PCI_INT[2]
D5	PCI_INT[3]
F2	LA[17]/DA[0]
G4	LA[18]/DA[1]
F3	LA[19]/DA[2]
F1	LA[20]/PCS1#
G2	LA[21]/PCS3#
G3	LA[22]/SCS1#
H2	LA[23]/SCS3#
J4	SA[0]
H1	SA[1]
H3	SA[2]
J2	SA[3]
J1	SA[4]
K2	SA[5]
J3	SA[6]
K1	SA[7]
K4	SA[8]/DD[0]
L2	SA[9]/DD[1]
K3	SA[10]/DD[2]
L1	SA[11]/DD[3]
M2	SA[12] / DD[4]
M1	SA[13] / DD[5]
L3	SA[14] / DD[6]
N2	SA[15] / DD[7]
M4	SA[16] / DD[8]
N1	SA[17] / DD[9]
M3	SA[18] / DD[10]
P4	SA[19] / DD[11]
P3	RTCDS / DD[12]
R2	RTCRW# / DD[13]
N3	KBCS# / DD[14]
P1	RMRTCCS# / DD[15]
R1	SD[0]
T2	SD[1]
R3	SD[2]
T1	SD[3]
R4	SD[4]
U2	SD[5]
T3	SD[6]
U1	SD[7]
U4	SD[8]
V2	SD[9]
U3	SD[10]

Pin #	Pin name
V1	SD[11]
W2	SD[12]
W1	SD[13]
V3	SD[14]
Y2	SD[15]
Y1	IOCHRDY
AE4	SYSRSET0x
AD4	ISA_CLK
AE5	ISA_CLK2X
AF8	OSC14M
W3	ALE
AC9	ZWS#
AA2	BHE#
Y4	MEMR#
AA1	MEMW#
Y3	SMEMR#
AB2	SMEMW#
AA3	IOR#
AC2	IOW#
AB4	MASTER#
AC1	MCS16#
AB3	IOCS16#
AD2	REF#
AC3	AEN
AD1	IOCHCK#
AF2	ISAOE#
A4	RTCAS#
AE3	GPIOCS#
B1	PIRQ
C2	SIRQ
C1	PDRQ
D2	SDRQ
D3	PDACK#
D1	SDACK#
E2	PIOR#
E4	PIOW#
E3	SIOR#
E1	SIOW#
E23	IRQ_MUX[0]
D26	IRQ_MUX[1]
E24	IRQ_MUX[2]
C25	IRQ_MUX[3]
A24	DREQ_MUX[0]
B23	DREQ_MUX[1]
C23	DACK_ENC[0]

Pin #	Pin name
A23	DACK_ENC[1]
B22	DACK_ENC[2]
D22	TC
C5	SPKRD
AD6	GREEN
AF6	BLUE
AD5	VSYN
AC5	HSYN
AD7	VREF_DAC
AE8	RSET
AF5	COMP
C7	DDC[0]
B5	DDC[1]
AC12	VCLK
AE13	VIN[0]
AD14	VIN[1]
AD12	VIN[2]
AE14	VIN[3]
AC14	VIN[4]
AF14	VIN[5]
AD13	VIN[6]
AE15	VIN[7]
AF10	RED_TV
AC10	GREEN_TV
AF11	BLUE_TV
AE10	VCS
AD9	ODD_EVEN
AD11	CVBS
AD8	IREF1_TV
AE9	VREF1_TV
AE11	IREF2_TV
AD10	VREF2_TV
B3	SCAN_ENABLE
AF12	VDDA_TV
AC7	VDD_DAC1
AF4	VDD_DAC2
AD19	VDD_GCLK_PLL
AF13	VDD_DCLK_PLL
F26	VDD_HCLK_PLL
G24	VDD_DEVCLK_PLL
A16	VDD5
B12	VDD5
B9	VDD5
D18	VDD5

PIN DESCRIPTION

Pin #	Pin name
A22	VDD
B14	VDD
C9	VDD
D6	VDD
D11	VDD
D16	VDD
D21	VDD
F4	VDD
F23	VDD
G1	VDD
K23	VDD
L4	VDD
L23	VDD
P2	VDD
T4	VDD
T23	VDD
T26	VDD
W4	VDD
AA4	VDD
AA23	VDD
AB1	VDD
AB23	VDD
AC6	VDD
AC11	VDD
AC16	VDD
AC21	VDD
AE12	VSSA_TV
AE7	VSS_DAC1
AF7	VSS_DAC2
E25	VSS_DLL
E26	VSS_DLL
A1:2	VSS
A26	VSS
B2	VSS
B25:26	VSS
C3	VSS
C24	VSS
D4	VSS
D9	VSS
D14	VSS
D19	VSS
D23	VSS
H4	VSS
J23	VSS
L11:16	VSS
M11:16	VSS
N4	VSS
N11:16	VSS

Pin #	Pin name
P11:16	VSS
P23	VSS
R11:16	VSS
T11:16	VSS
V4	VSS
W23	VSS
AC4	VSS
AC8	VSS
AC13	VSS
AC18	VSS
AC23	VSS
AD3	VSS
AD24	VSS
AE1:2	VSS
AE16	VSS
AE25	VSS
AF1	VSS
AF25	VSS
AF26	VSS
C26	RESERVED
D24	RESERVED
B24	RESERVED
A25	RESERVED

ELECTRICAL SPECIFICATIONS

3 ELECTRICAL SPECIFICATIONS

3.1 Introduction

The electrical specifications in this chapter are valid for the STPC Consumer.

3.2 Electrical Connections

3.2.1 Power/Ground Connections/Decoupling

Due to the high frequency of operation of the STPC Consumer, it is necessary to install and test this device using standard high frequency techniques. The high clock frequencies used in the STPC Consumer and its output buffer circuits can cause transient power surges when several output buffers switch output levels simultaneously. These effects can be minimized by filtering the DC power leads with low-inductance decoupling capacitors, using low impedance wiring, and by utilizing all of the VSS and VDD pins.

3.2.2 Unused Input Pins

All inputs not used by the designer and not listed in the table of pin connections in Chapter 3 should

be connected either to VDD or to VSS. Connect active-high inputs to VDD through a 20 kΩW ($\pm 10\%$) pull-down resistor and active-low inputs to VSS and connect active-low inputs to VCC through a 20 kΩW ($\pm 10\%$) pull-up resistor to prevent spurious operation.

3.2.3 Reserved Designated Pins

Pins designated reserved should be left disconnected. Connecting a reserved pin to a pull-up resistor, pull-down resistor, or an active signal could cause unexpected results and possible circuit malfunctions.

3.3 Absolute Maximum Ratings

The following table lists the absolute maximum ratings for the STPC Consumer device. Stresses beyond those listed under Table 4 limits may cause permanent damage to the device. These are stress ratings only and do not imply that operation under any conditions other than those specified in section "Operating Conditions".

Exposure to conditions beyond Table 4 may (1) reduce device reliability and (2) result in premature failure even when there is no immediately apparent sign of failure. Prolonged exposure to conditions at or near the absolute maximum ratings (Table 4) may also result in reduced useful life and reliability.

Table 4. Absolute Maximum Ratings

Symbol	Parameter	Value	Units
V _{DDx}	DC Supply Voltage	-0.3, 4.0	V
V _I , V _O	Digital Input and Output Voltage	-0.3, VDD + 0.3	V
T _{STG}	Storage Temperature	-40, +150	°C
T _{OPER}	Operating Temperature	0, +70	°C
P _{TOT}	Total Power Dissipation	4.8	W

3.4 DC Characteristics

Table 5. DC Characteristics

Recommended Operating conditions : $V_{DD} = 3.3V \pm 0.3V$, $T_{case} = 0$ to $100^{\circ}C$ unless otherwise specified

Symbol	Parameter	Test conditions	Min	Typ	Max	Unit
V_{DD}	Operating Voltage		3.0	3.3	3.6	V
P_{DD}	Supply Power	$V_{DD} = 3.3V$, $H_{CLK} = 66Mhz$		3.2	3.9	W
H_{CLK}	Internal Clock	(Note 1)			75	Mhz
V_{REF}	DAC Voltage Reference		1.215	1.235	1.255	V
V_{OL}	Output Low Voltage	$I_{Load} = 1.5$ to $8mA$ depending of the pin			0.5	V
V_{OH}	Output High Voltage	$I_{Load} = -0.5$ to $-8mA$ depending of the pin	2.4			V
V_{IL}	Input Low Voltage	Except XTALI	-0.3		0.8	V
		XTALI	-0.3		0.9	V
V_{IH}	Input High Voltage	Except XTALI	2.1		$V_{DD}+0.3$	V
		XTALI	2.35		$V_{DD}+0.3$	V
I_{LK}	Input Leakage Current	Input, I/O	-5		5	μA
C_{IN}	Input Capacitance	(Note 2)				pF
C_{OUT}	Output Capacitance	(Note 2)				pF
C_{CLK}	Clock Capacitance	(Note 2)				pF

Notes:

1. MHz ratings refer to CPU clock frequency.
2. Not 100% tested.

3.5 AC Characteristics

Table 7 through Table 12 list the AC characteristics including output delays, input setup requirements, input hold requirements and output float delays. These measurements are based on the measurement points identified in Figure 8 and Figure 9. The rising clock edge reference level V_{REF} , and other reference levels are shown in Table 6 below for the STPC Consumer. Input or output signals must cross these levels during testing.

Figure 8 shows output delay (A and B) and input setup and hold times (C and D). Input setup and hold times (C and D) are specified minimums, defining the smallest acceptable sampling window a synchronous input signal must be stable for correct operation.

Table 6. Drive Level and Measurement Points for Switching Characteristics

Symbol	Value	Units
V_{REF}	1.5	V
V_{IHD}	3.0	V
V_{ILD}	0.0	V

Note: Refer to Figure 8.

ELECTRICAL SPECIFICATIONS

Figure 8. Drive Level and Measurement Points for Switching Characteristics

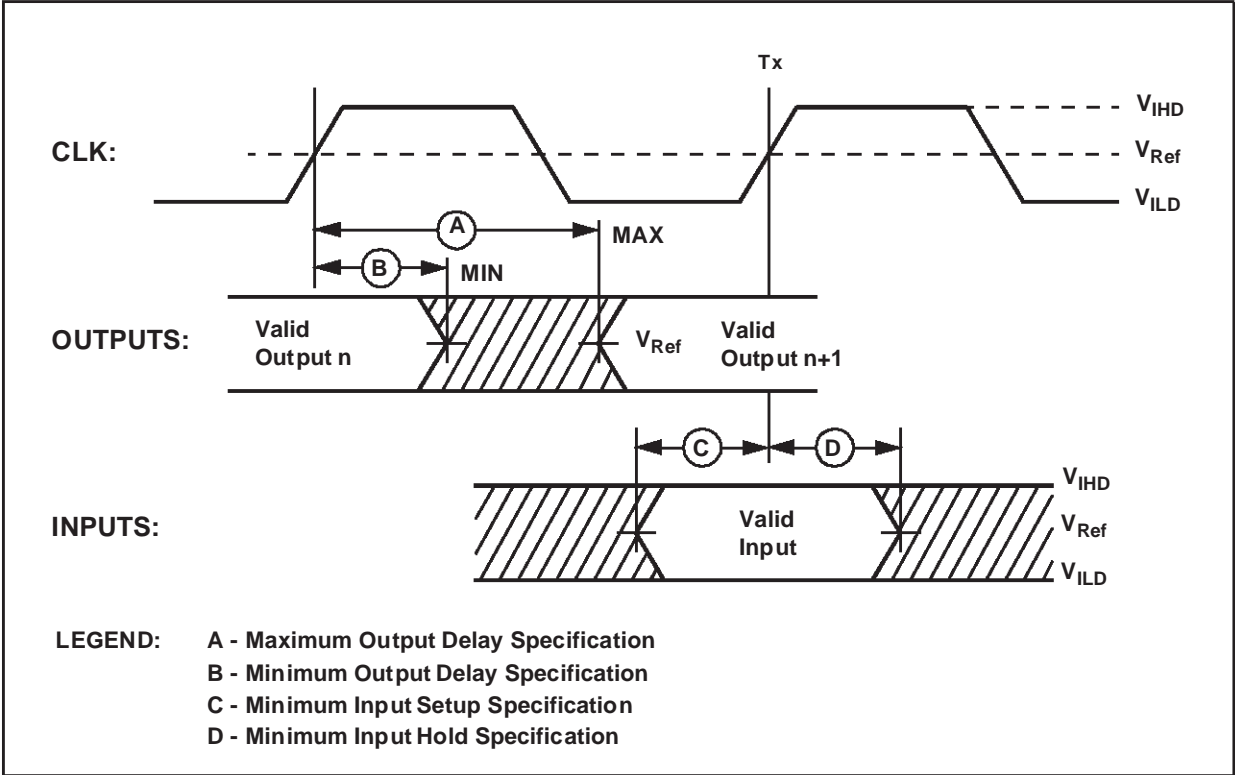


Figure 9. CLK Timing Measurement Points

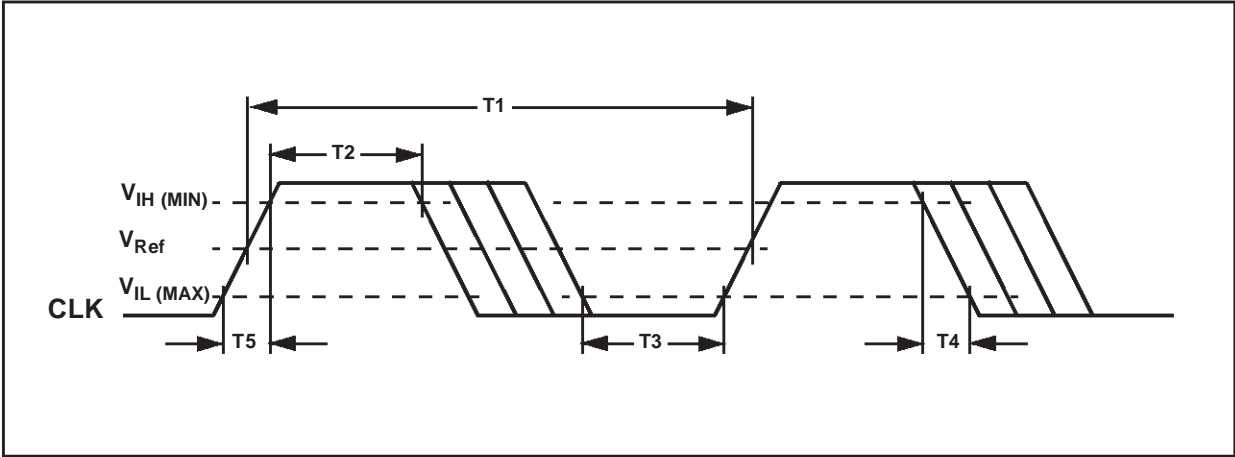


Table 7. PCI Bus AC Timing

Name	Parameter	Min	Max	Unit
t1	PCI_CLKI to AD[31:0] valid	2	11	ns
t2	PCI_CLKI to FRAME# valid	2	11	ns
t3	PCI_CLKI to CBE#[3:0] valid	2	11	ns
t4	PCI_CLKI to PAR valid	2	11	ns
t5	PCI_CLKI to TRDY# valid	2	11	ns
T6	PCI_CLKI to IRDY# valid	2	11	ns
T7	PCI_CLKI to STOP# valid	2	11	ns
T8	PCI_CLKI to DEVSEL# valid	2	11	ns
T9	PCI_CLKI to PCI_GNT# valid	2	12	ns
t10	AD[31:0] bus setup to PCI_CLKI	7		ns
t11	AD[31:0] bus hold from PCI_CLKI	0		ns
t12	PCI_REQ#[2:0] setup to PCI_CLKI	10		ns
t13	PCI_REQ#[2:0] hold from PCI_CLKI	0		ns
t14	CBE#[3:0] setup to PCI_CLKI	7		ns
t15	CBE#[3:0] hold to PCI_CLKI	0		ns
t16	IRDY# setup to PCI_CLKI	7		ns
t17	IRDY# hold to PCI_CLKI	0		ns
t18	FRAME# setup to PCI_CLKI	7		ns
t19	FRAME# hold from PCI_CLKI	0		ns

Table 8. IDE Bus AC Timing

Name	Parameter	Min	Max	Unit
t20	DD[15:0] setup to PIOR#/SIOR# falling	15		ns
t21	DD[15:0] hold to PIOR#/SIOR# falling	12		ns

Table 9. DRAM Bus AC Timing

Name	Parameter	Min	Max	Unit
t22	HCLK to RAS#[3:0] valid		15	ns
t23	HCLK to CAS#[7:0] bus valid		15	ns
t24	HCLK to MA[11:0] bus valid		15	ns
t25	HCLK to MWE# valid		15	ns
t26	HCLK to MD[63:0] bus valid		19	ns
t27	MD[63:0] Generic setup			ns
t28	GCLK2X to RAS#[3:0] valid		15	ns
t29	GCLK2X to CAS#[7:0] valid		15	ns
t30	GCLK2X to MA[11:0] bus valid		15	ns
t31	GCLK2X to MWE# valid		15	ns
t32	GCLK2X to MD[63:0] bus valid		18	ns
t33	MD[63:0] Generic hold			ns

ELECTRICAL SPECIFICATIONS

Table 10. Video Input/TV Output AC Timing

Name	Parameter	Min	Max	Unit
t35	VIDEO_D[7:0] setup to VCLK	5		ns
t36	VIDEO_D[7:0] hold from VCLK	2		ns
t37	VCLK to VTV_BT# valid		15	ns
t38	VCLK to VTV_HSYNC valid		15	ns
t39	VTB_BT# setup to VCLK	10		ns
t40	VTB_BT# hold from VCLK	5		ns
t41	VTB_HSYNC setup to VCLK	10		ns
t42	VTB_HSYNC hold from VCLK	5		ns

Table 11. Graphics Adapter (VGA) AC Timing

Name	Parameter	Min	Max	Unit
t43	DCLK to VSYNC valid		45	ns
t44	DCLK to HSYNC valid		45	ns

Table 12. ISA Bus AC Timing

Name	Parameter	Min	Max	Unit
t45	XTALO to LA[23:17] bus active		60	ns
t46	XTALO to SA[19:0] bus active		60	ns
t47	XTALO to BHE# valid		62	ns
t48	XTALO to SD[15:0] bus active		35	ns
t49	PCI_CLKI to ISAOE# valid		28	ns
t50	XTALO to GPIOCS# valid		60	ns
t51	XTALO to ALE valid		62	ns
t52	XTALO to MEMW# valid		50	ns
t53	XTALO to MEMR# valid		50	ns
t54	XTALO to SMEMW# valid		50	ns
t55	XTALO to SMEMR# valid		50	ns
t56	XTALO to IOR# valid		50	ns
t57	XTALO to IOW# valid		50	ns

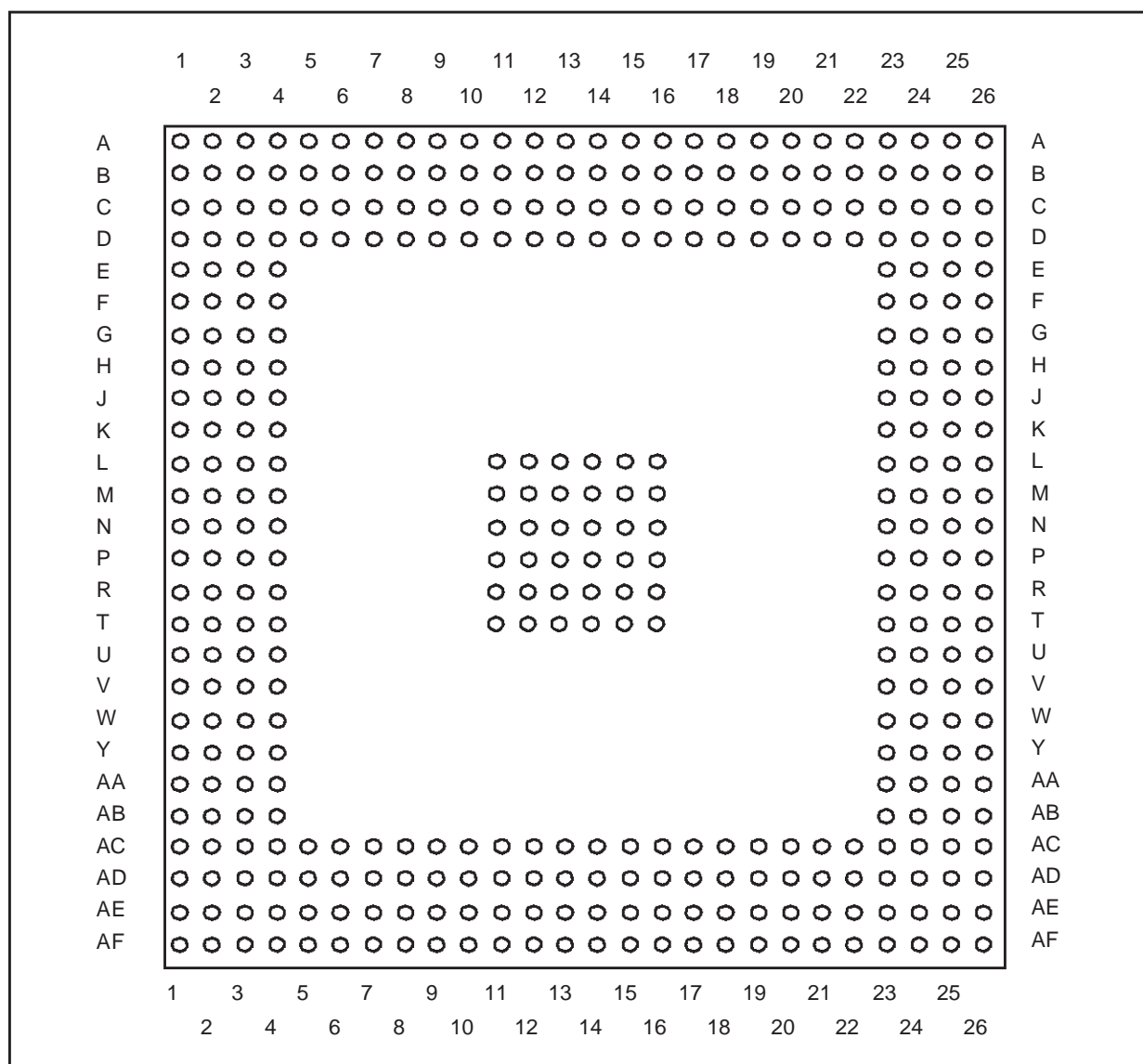
4 MECHANICAL DATA

4.1 388-Pin Package

The pin numbering for the STPC 388-pin Plastic BGA package is shown in Figure 10.

Dimensions are shown in Figure 11, Table 13 and Figure 12, Table 14.

Figure 10. 388-Pin PBGA Package - Top View



MECHANICAL DATA

Figure 11. 388-Pin PBGA Package - Dimensions

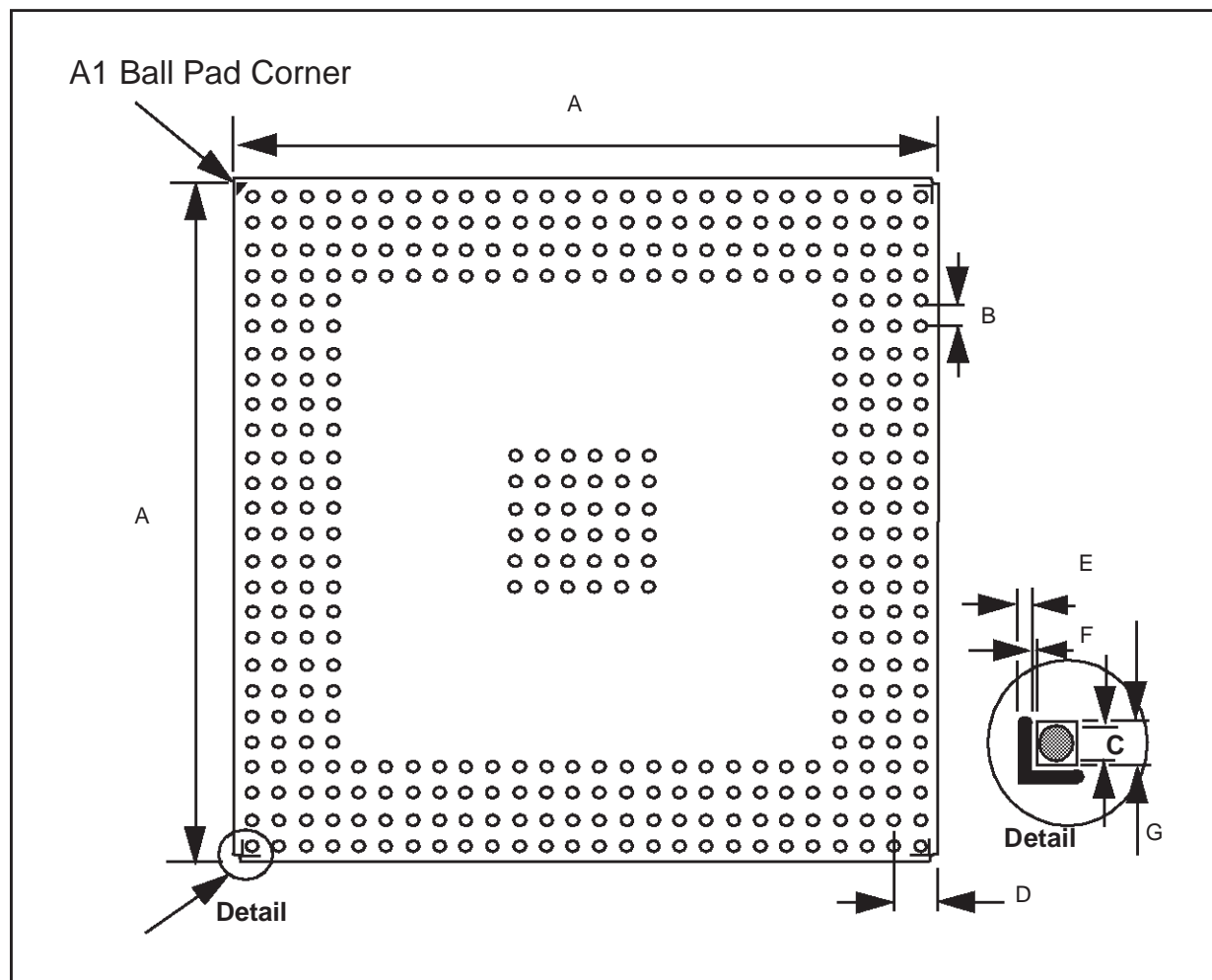


Table 13. PBGA388 - 388 Solder Ball Plastic 35mm x 35mm

Symbols	mm			inches		
	Min	Typ	Max	Min	Typ	Max
A	34.95	35.00	35.05	1.375	1.378	1.380
B	1.22	1.27	1.32	0.048	0.050	0.052
C	0.58	0.63	0.68	0.023	0.025	0.027
D	1.57	1.62	1.67	0.062	0.064	0.066
E	0.15	0.20	0.25	0.006	0.008	0.01
F	0.05	0.10	0.15	0.002	0.004	0.006
G	0.75	0.80	0.85	0.030	0.032	0.034

Figure 12. 388-Pin PBGA Package - Dimensions (Continued)

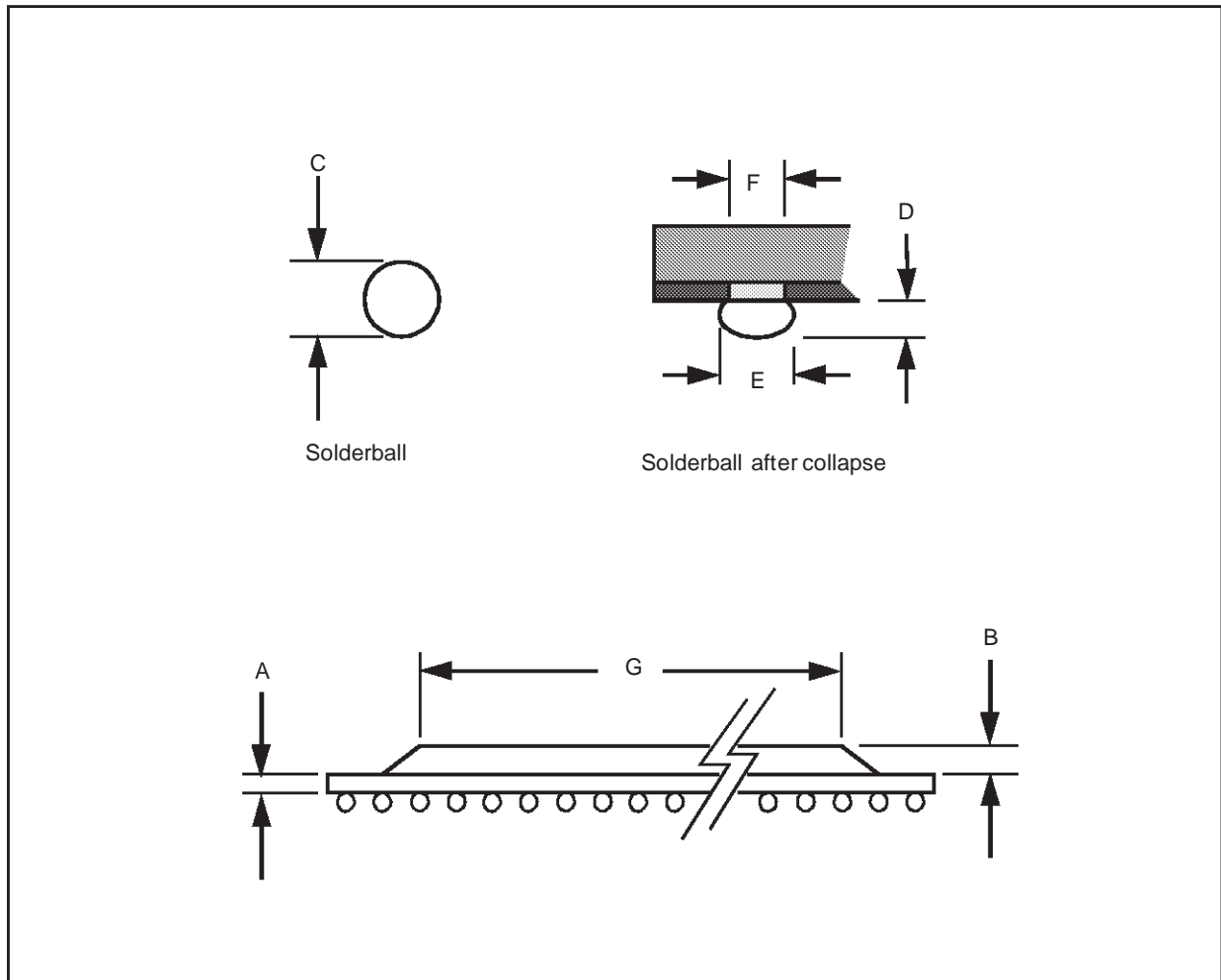


Table 14. PBGA388 - 388 Solder Ball Plastic 35mm x 35mm (Continued)

Symbols	mm			inches		
	Min	Typ	Max	Min	Typ	Max
A	0.50	0.56	0.62	0.020	0.022	0.024
B	1.12	1.17	1.22	0.044	0.046	0.048
C	0.60	0.76	0.92	0.024	0.030	0.036
D	0.52	0.53	0.54	0.020	0.021	0.022
E	0.63	0.78	0.93	0.025	0.031	0.037
F	0.60	0.63	0.66	0.024	0.025	0.026
G		30.0			11.8	

ORDERING DATA

5 ORDERING DATA

5.1 Ordering Codes

	ST	PC	C01	66	BT	C	3
STMicroelectronics Prefix							
Product Family PC: PC Compatible							
Product ID C01: Consumer							
Core Speed 66: 66MHz 75: 75MHz 80: 80MHz 10: 100MHz 12: 120MHz 13: 133MHz							
Package BT: 388 Overmoulded BGA							
Temperature Range C: Commercial 0 to +70°C Tcase = 0 to +100°C I: Industrial -40 to +85°C Tcase = -40 to +100°C							
Operating Voltage 3 : 3.3V ± 10%							

5.2 Available Part Numbers

Part Number	Core Frequency (MHz)	Temperature Range (C)	Operating Voltage (V)
STPCC0166BTC3	66	0 to + 70°	3.3V ± 10%
STPCC0175BTC3	75		
STPCC0180BTC3	80		
STPCC0110BTC3	100		
STPCC0112BTC3	120		

5.3 Customer Service

More informations are available on STMicroelectronics internet site <http://www.st.com/stpc>

For technical support, a mail-box is in place at stpc.support@st.com

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